

500mA LDO in 1.6mm × 1.6mm Package

### **General Description**

The MIC5353 is a high-performance, single-output, ultralow LDO (ULDO<sup>TM</sup>) regulator, offering a low total output noise of  $30\mu V_{RMS}$ . The MIC5353 is capable of sourcing 500mA output current and offers high-PSRR and lowoutput noise, making it an ideal solution for RF applications.

The MIC5353 provides 2% accuracy, extremely low dropout voltage (160mV @ 500mA), and low ground current (typically 90 $\mu$ A) making it ideal for battery-operated applications. When disabled, the MIC5353 enters a zero-off-mode current state, thereby drawing almost no current.

The MIC5353 is available in the 1.6mm x 1.6mm Thin MLF<sup>®</sup> package, occupying only 2.56mm<sup>2</sup> of PCB area, a 36% reduction in board area compared to SC-70 and 2mm x 2mm Thin MLF<sup>®</sup> packages.

The MIC5353 has an operating junction temperature range of –40°C to +125°C and is available in fixed and adjustable output voltages in lead-free (RoHS-compliant) Thin  $\rm MLF^{\circledast}$  package.

Data sheets and support documentation can be found on Micrel's web site at: <u>www.micrel.com</u>.

### Features

- 500mA guaranteed output current
- Input voltage range: 2.6V to 6V
- Ultra low dropout voltage: 160mV @ 500mA
- ±2% initial accuracy
- Ultra low output noise: 30µVrms
- Low quiescent current: 90µA
- · Stable with ceramic output capacitors
- 35µs turn-on time
- Thermal shutdown and current limit protection
- Tiny 6-pin 1.6mm x 1.6mm Thin MLF<sup>®</sup> leadless package

#### **Applications**

- Mobile Phones
- GPS, PDAs, PMP, handhelds
- Portable electronics
- Digital still and video cameras
- Digital TV

### **Typical Application**



**Portable Application** 

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# **Ordering Information**

Part Number	Marking Code <sup>(1)</sup>	Output Voltage <sup>(2)</sup>	Temperature Range	Package
MIC5353-1.8YMT	18R	1.8V	–40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin $MLF^{^{ extsf{B}}}$
MIC5353-2.5YMT	25R	2.5V	–40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin $MLF^{^{(\!\!R)}}$
MIC5353-2.6YMT	26R	2.6V	-40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin MLF <sup>®</sup>
MIC5353-2.8YMT	28R	2.8V	–40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin MLF <sup>®</sup>
MIC5353-3.0YMT	30R	3.0V	-40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin MLF <sup>®</sup>
MIC5353-3.3YMT	33R	3.3V	-40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin MLF <sup>®</sup>
MIC5353YMT	AAR	ADJ	–40°C to +125°C	6-Pin 1.6mm x 1.6mm Thin MLF <sup>®</sup>

Notes:

1. Pin 1 identifier= "▲".

2. For other voltage options contact Micrel Marketing.

3. Thin MLF® is a GREEN RoHS compliant package. Lead finish is NiPdAu, Mold compound is Halogen Free.

# Pin Configuration



6-Pin 1.6mm × 1.6mm Thin MLF<sup>®</sup> (MT) Fixed (TOP VIEW)



6-Pin 1.6mm × 1.6mm Thin MLF<sup>®</sup>(MT) Adjustable (TOP VIEW)

## **Pin Description**

Pin Number Thin MLF-6 Fixed	Pin Number Thin MLF-6 Adjustable	Pin Name	Pin Function
1	1	EN	Enable Input. Active High. High = ON, low = OFF. Do not leave floating.
2	2	GND	Ground.
3	3	VIN	Supply Input.
4	4	VOUT	Output Voltage.
5	-	NC	No connection.
-	5	ADJ	Adjust Input. Connect to external resistor voltage divider network.
6	6	BYP	Reference Bypass: Connect external $0.1 \mu F$ to GND for reduced Output Noise. May be left open.
EPad	EPad	HS PAD	Exposed Heat-sink Pad connected to ground internally.

## Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage (V <sub>IN</sub> )	-0.3V to +6.5V
Enable Input Voltage (V <sub>EN</sub> )	0.3V to V <sub>IN</sub>
Enable Input Voltage (V <sub>EN</sub> ) Power Dissipation	Internally Limited <sup>(3)</sup>
Lead Temperature (soldering, 3sec)	260°C
Junction Temperature (T <sub>J</sub> )	40°C to +125°C
Storage Temperature (T <sub>S</sub> ) ESD Rating <sup>(4)</sup>	–65°C to +150°C
ESD Rating <sup>(4)</sup>	2KV

## **Operating Ratings**<sup>(2)</sup>

Supply Voltage (V <sub>IN</sub> )	+2.6V to +6.0V
Enable Input Voltage (V <sub>EN</sub> )	
Junction Temperature (T <sub>J</sub> )	40°C to +125°C
Junction Thermal Resistance	
6-Pin 1 6mm x1 6mm Thin MI F <sup>®</sup> (θ.,	) 92 4°C/M

6-Pin 1.6mm x1.6mm Thin MLFຶ (θ<sub>JA</sub>) ......92.4°C/W

## Electrical Characteristics<sup>(5)</sup>

 $V_{IN} = V_{OUT} + 1.0V; C_{OUT} = 1.0\mu F; I_{OUT} = 100\mu A; T_J = 25^{\circ}C, \text{ bold } values indicate -40^{\circ}C \text{ to } +125^{\circ}C, unless noted.$ 

Parameter	Conditions	Min.	Тур.	Max.	Units	
	Variation from nominal V <sub>OUT</sub>	-2.0		+2.0	- %	
Output Voltage Accuracy	Variation from nominal V <sub>OUT</sub> ; –40°C to +125°C	-3.0		+3.0		
Line Degulation	$V_{IN} = V_{OUT} + 1V \text{ to } 6V; I_{OUT} = 100 \mu A$		0.05	0.3	%/V	
Line Regulation	$v_{\rm IN} = v_{\rm OUT} + 1 v_{\rm IO} 0 v, n_{\rm OUT} = 100 \mu A$			0.6	70/ V	
Load Regulation	I <sub>OUT</sub> = 100μA to 500mA		0.15	2.0	%	
	I <sub>OUT</sub> = 150mA		50	100		
Dropout Voltage <sup>(6)</sup>	I <sub>OUT</sub> = 300mA		100	200	mV	
	I <sub>OUT</sub> = 500mA		160	350		
Ground Pin Current	I <sub>OUT</sub> = 0 to 500mA		90	175	μA	
Ground Pin Current in Shutdown	V <sub>EN</sub> ≤ 0.2V		0.01	2	μA	
Dinale Dejection	$f = 1 kHz; C_{OUT} = 1.0 \mu F; C_{BYP} = 0.1 \mu F$		60		dB	
Ripple Rejection	$f = 20kHz; C_{OUT} = 1.0\mu F; C_{BYP} = 0.1\mu F$		45			
Current Limit	V <sub>OUT</sub> = 0V	600	1100	1600	mA	
Output Voltage Noise	$C_{OUT} = 1.0 \mu F$ ; $C_{BYP} = 0.1 \mu F$ ; 10Hz to 100kHz		30		μV <sub>RMS</sub>	
Enable Input					•	
	Logic Low			0.2	N	
Enable Input Voltage	Logic High	1.2			- V	
	$V_{IL} \leq 0.2V$		0.01	1		
Enable input Current	able Input Current $V_{\rm IH} \ge 1.2V$ 0.01		1	μA		
Turn-on Time	·	•	•	•		
Turn-on Time	$C_{OUT} = 1.0 \mu F; C_{BYP} = 0.1 \mu F$		35	100	μs	

Notes:

1. Exceeding the absolute maximum rating may damage the device.

2. The device is not guaranteed to function outside its operating rating.

3. The maximum allowable power dissipation of any  $T_A$  (ambient temperature) is  $P_{D(max)} = (T_{J(max)} - T_A) / \theta_{JA}$ . Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.

4. Devices are ESD sensitive. Handling precautions recommended. Human body model  $1.5 K\Omega$  in series with 100 pF.

5. Specification for packaged product only.

Dropout voltage is defined as the input-to-output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.

### **Functional Diagram**









# **Typical Characteristics**



### **Functional Characteristics**





## Applications Information

#### Enable/Shutdown

The MIC5353 comes with an active-high enable pin that allows the regulator to be disabled. Forcing the enable pin low disables the regulator and sends it into a "zero" off-mode-current state. In this state, current consumed by the regulator goes nearly to zero. Forcing the enable pin high enables the output voltage. The active-high enable pin uses CMOS technology and the enable pin cannot be left floating; a floating enable pin may cause an indeterminate state on the output.

#### Input Capacitor

The MIC5353 is a high-performance, high bandwidth device. Therefore, it requires a well-bypassed input supply for optimal performance. A  $1\mu$ F capacitor is required from the input-to-ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. The use of additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit.

#### **Output Capacitor**

The MIC5353 requires an output capacitor of  $1\mu$ F or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors may cause high-frequency oscillation. The output capacitor can be increased, although performance has been optimized for a  $1\mu$ F ceramic output capacitor and doing so does not improve significantly with larger capacitance.

dielectric-type X7R/X5R ceramic capacitors are because recommended of their temperature performance. The X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor thereby ensuring the same minimum capacitance over the equivalent operating temperature range.

### **Bypass Capacitor**

A capacitor can be placed from the noise bypass pin-toground to reduce output voltage noise. The capacitor bypasses the internal reference. A  $0.1\mu$ F capacitor is recommended for applications that require low-noise outputs. The bypass capacitor can be increased, further reducing noise and improving PSRR. Turn-on time increases slightly with respect to bypass capacitance. A unique, quick-start circuit allows the MIC5353 to drive a large capacitor on the bypass pin without significantly slowing turn-on time.

### **No-Load Stability**

Unlike many other voltage regulators, the MIC5353 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

#### Adjustable Regulator Application

Adjustable regulators use the ratio of two resistors to multiply the reference voltage to produce the desired output voltage. The MIC5353 can be adjusted from 1.25V to 5.5V by using two external resistors (Figure 1). The resistors set the output voltage based on the following equation:

$$V_{OUT} = V_{REF} \left( 1 + \frac{R1}{R2} \right)$$

$$V_{REF} = 1.25V$$



Figure 1. Adjustable Voltage Output

#### Thermal Considerations

The MIC5353 is designed to provide 500mA of continuous current. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. Given that the input voltage is 3.3V, the output voltage is 2.8V and the output current = 500mA.

The actual power dissipation of the regulator circuit can be determined using the equation:

$$P_{D} = (V_{IN} - V_{OUT}) I_{OUT} + V_{IN} I_{GND}$$

Because this device is CMOS and the ground current is typically  $<100\mu$ A over the load range, the power dissipation contributed by the ground current is < 1% and can be ignored for this calculation:

 $P_{D} = (3.3V - 2.8V) \times 500 \text{mA}$ 

 $P_{D} = 0.25W$ 

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

$$\mathsf{P}_{\mathsf{D}(\mathsf{MAX})} = \left( \underbrace{\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} - \mathsf{T}_{\mathsf{A}}}_{\theta_{\mathsf{J}\mathsf{A}}} \right)$$

 $T_{J(max)}$  = 125°C, the maximum junction temperature of the die  $\theta_{JA}$  thermal resistance = 92.4°C/W.

#### **Thermal Resistance**

Substituting  $P_D$  for  $P_{D(max)}$  and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The junction-to-ambient thermal resistance for the minimum footprint is 92.4°C/W.

The maximum power dissipation must not be exceeded for proper operation.

For example, when operating the MIC5353-2.8YMT at an input voltage of 3.3V and 500mA load with a minimum footprint layout, the maximum ambient operating temperature  $T_A$  can be determined as follows:

$$0.25W = (125^{\circ}C - T_A)/(92.4^{\circ}C/W)$$
  
 $T_A=101^{\circ}C$ 

Therefore, a 2.8V application with 500mA of output current can accept an ambient operating temperature of 101°C in a 1.6mm x 1.6mm Thin MLF<sup>®</sup> package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the "Regulator Thermals" section of Micrel's *Designing with Low-Dropout Voltage Regulators* handbook. This information can be found on Micrel's website at:

http://www.micrel.com/\_PDF/other/LDOBk\_ds.pdf

## **Typical Application Schematic (Fixed Output)**



### **Bill of Materials**

ltem	Part Number	Manufacturer	Description	Qty.
C1,C3	06036D105KAT2A	AVX <sup>(1)</sup>	Capacitor, 1µF Ceramic, 6.3V, X5R, Size 0603	2
	GRM188R60J105KE19D	muRata <sup>(2)</sup>		Z
C2	06035C104KAT2A	AVX <sup>(1)</sup>	Consister 0.4. Coronia 501/ XED Size 0602	1
	GRM188R71H104KA93D	muRata <sup>(2)</sup>	Capacitor, 0.1µF Ceramic, 50V, X5R, Size 0603	
U1	MIC5353-XXYMT	Micrel, Inc. <sup>(3)</sup>	500mA LDO, 1.6mm x 1.6mm Thin MLF <sup>®</sup>	1

Notes:

1. AVX: <u>www.avx.com</u>.

2. Murata Tel: <u>www.murata.com</u>.

3. Micrel, Inc.: <u>www.micrel.com</u>.

## **Typical Application Schematic (Adjustable Output)**



### **Bill of Materials**

ltem	Part Number	Manufacturer	Description	Qty.
C1,C3	06036D105KAT2A	AVX <sup>(1)</sup>	Capacitor, 1µF Ceramic, 6.3V, X5R, Size 0603	2
	GRM188R60J105KE19D	muRata <sup>(2)</sup>		2
C2	06035C104KAT2A	AVX <sup>(1)</sup>		4
	GRM188R71H104KA93D	muRata <sup>(2)</sup>	Capacitor, 0.1µF Ceramic, 50V, X5R, Size 0603	I
R1	CRCW060320K0FKEA	Vishay <sup>(3)</sup>	Resistor, 20kΩ, 1%, 1/16W, Size 0603	
R2	CRCW060310K0FKEA	Vishay <sup>(3)</sup>	Resistor, 10kΩ, 1%, 1/16W, Size 0603	1
U1	MIC5353YMT	Micrel, Inc. <sup>(4)</sup>	Adjustable 500mA LDO, 1.6mm x 1.6mm Thin $\mathrm{MLF}^{^{(0)}}$	1

Notes:

1. AVX: <u>www.avx.com</u>.

2. Murata Tel: <u>www.murata.com</u>.

3. Vishay Tel: <u>www.vishay.com</u>.

4. Micrel, Inc.: <u>www.micrel.com</u>.

### **PCB Layout Recommendations**



BOTTOM LAYER

### **Package Information**



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